Panasonic

# MA2J7290G

#### Silicon epitaxial planar type

For super high speed switching For small current rectification

#### Features

- Forward current (Average)  $I_{F(AV)} = 200$  mA rectification is possible
- High-density mounting is possible

- Package
- Code
- SMini2-F3
- Pin Name
- 1: Anode 2: Cathode
- 2: Cathode

Marking Symbol: 2B

<b>0</b> "					
Parameter	Symbol	Rating	Unit		
Reverse voltage	V <sub>R</sub>	30	V		
Repetitive peak reverse voltage	V <sub>RRM</sub>	30	V		
Forward current (Average)	I <sub>F(AV)</sub>	200	mA		
Peak forward current	I <sub>FM</sub>	300	mA		
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	1	А		
Junction temperature	Tj	150	°C		
Storage temperature	T <sub>stg</sub>	-55 to +150	°C		

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

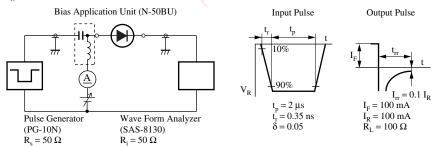
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 200 \text{ mA}$	S ~	5	0.55	V
Reverse current	OI <sub>R</sub>	$V_R = 30 V$	0		50	μΑ
Terminal capacitance	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$	0.X	30		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$	r	3.0		ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

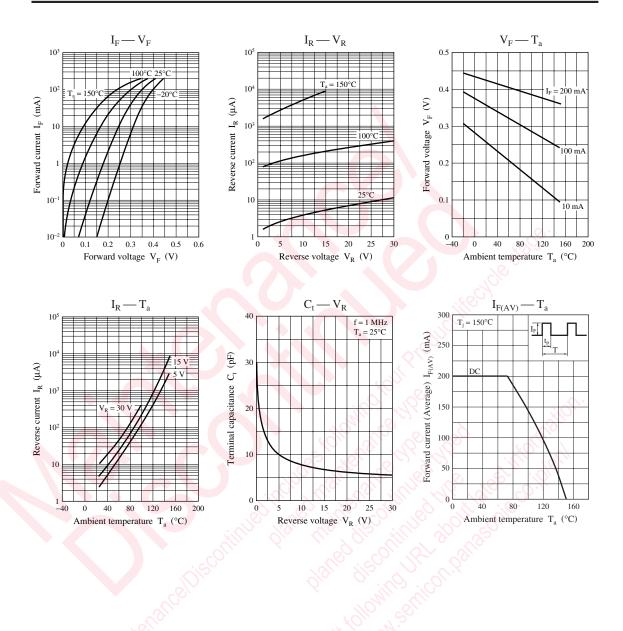
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

- 3. Absolute frequency of input and output is 1 GHz.
- 4. \*: t<sub>rr</sub> measurement circuit



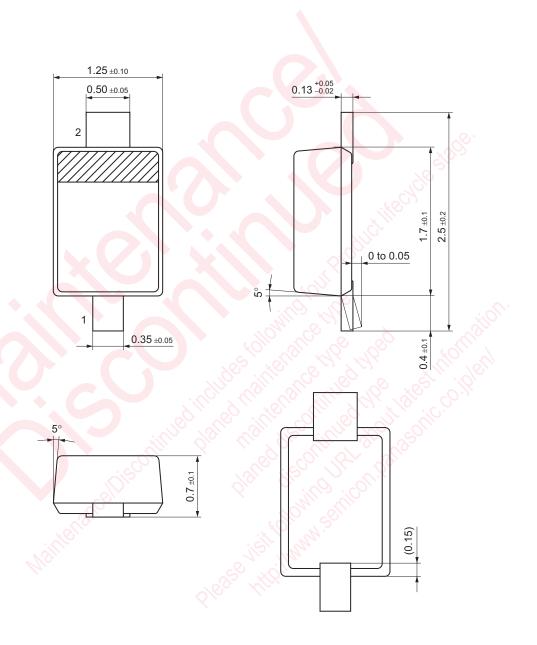
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### SMini2-F3

Unit: mm



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